

MOSFET

650V CoolMOS™ CFD7A SJ Power Device

650V CoolMOS™ CFD7A is Infineon's latest generation of market leading automotive qualified high voltage CoolMOS™ MOSFETs. In addition to the well-known attributes of high quality and reliability required by the automotive industry, the new CoolMOS™ CFD7A series provides for an integrated fast body diode and can be used for PFC and resonant switching topologies like the ZVS phase-shift full-bridge and LLC.

Features

- \bullet Latest 650V automotive qualified technology with integrated fast body diode on the market featuring ultra low $Q_{\rm rr}$
- Lowest FOM R_{DS(on)}*Q_g and R_{DS(on)}*E_{oss}
- 100% avalanche tested
- · Kelvin source contact available
- Best-in-class R_{DS(on)} in SMD and THD packages

Benefits

- Optimized for higher battery voltages up to 475 V thanks to further improved robustness
- · Lower switching losses enabling higher switching frequencies
- High quality and reliability
- Advanced controllability due to kelvin source
- Increased package creepage distance
- Increased efficiency in light load and full load conditions

Potential applications

Suitable for PFC and DC-DC stages for:

- Unidirectional and bidirectional DC-DC converters,
- · On-Board battery Chargers

Product validation

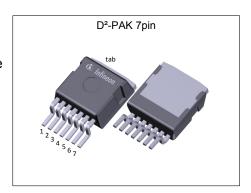
Qualified according to AEC Q101

Please note: The source and sense source pins are not exchangeable. Their exchange might lead to malfunction. For production part approval process (PPAP) release we propose to share application related information during an early design phase to avoid delays in PPAP release. Please contact Infineon sales office.



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Parameter	Value	Unit						
V _{DS}	650	V						
R _{DS(on),max}	50	mΩ						
$Q_{g,typ}$	102	nC						
$I_{D,pulse}$	211	A						
E _{oss} @ 400V	13.0	μJ						
Body diode di _F /dt	1300	A/µs						

Type / Ordering Code	Package	Marking	Related Links
IPBE65R050CFD7A	PG-TO263-7-11	65A050F7	see Appendix A



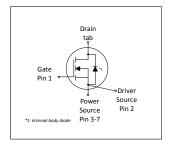














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1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	Cumbal		Value	s	l lmit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	45 29	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	211	Α	T _C =25°C	
Avalanche energy, single pulse	E _{AS}	-	-	248	mJ	I _D =6.4A; V _{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	6.4	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	$V_{GSk,pulse}$	-30	-	30	V	f _{repetition} <=100kHz, t _{pulse} <= 2ns	
Power dissipation	P _{tot}	-	-	227	W	T _C =25°C	
Storage temperature	T _{stg}	-55	-	150	°C	-	
Operating junction temperature	T _j	-40	-	150	°C	-	
Mounting torque	-	-	-	-	Ncm	-	
Continuous diode forward current	Is	-	-	45	Α	T _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	211	Α	T _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	70	V/ns	V_{DS} =0400V, I_{SD} <=24.8A, T_{j} =25°C see table 8	
Maximum diode commutation speed	di _F /dt	-	-	1300	A/μs	V _{DS} =0400V, I _{SD} <=24.8A, T _j =25°C see table 8	

 $^{^{1)}}$ Limited by $T_{j\;max}.$ $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical $R_{\rm G}$

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2 Thermal characteristics

Table 3 Thermal characteristics

Doromotor	Cumbal	Values			l lmi4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.55	°C/W	-
Soldering temperature, reflow soldering allowed	T _{sold}	-	-	260	°C	reflow MSL1

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3 Electrical characteristics

at T_i =25°C, unless otherwise specified

Table 4 Static characteristics

For applications with applied blocking voltage > 475 V, it is required that the customer evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon.

Parameter	Oh a l		Values			Note / Took Open Hittory
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	650	-	-	V	V _{GS} =0V, I _D =1mA
Gate threshold voltage ¹⁾	$V_{\rm (GS)th}$	3.5	4	4.5	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =1.24mA
Zero gate voltage drain current	I _{DSS}	-	- 120	1 -	μА	V _{DS} =650V, V _{GS} =0V, T _j =25°C V _{DS} =650V, V _{GS} =0V, T _j =150°C
Gate-source leakage current	I _{GSS}	-	-	0.1	μΑ	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.041 0.092	0.050	Ω	V _{GS} =10V, I _D =24.8A, T _i =25°C V _{GS} =10V, I _D =24.8A, T _i =150°C
Gate resistance	R _G	-	3.8	-	Ω	f=250kHz, open drain

Table 5 Dynamic characteristics

External parasitic elements (PCB layout) influence switching behavior significantly.

Stray inductances and coupling capacitances must be minimized.

For layout recommendations please use provided application notes or contact Infineon sales office.

D	0	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	Ciss	-	4975	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Output capacitance	Coss	-	68	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Effective output capacitance, energy related ²⁾	C _{o(er)}	-	163	-	pF	V _{GS} =0V, V _{DS} =0400V	
Effective output capacitance, time related ³⁾	C _{o(tr)}	-	1712	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V	
Turn-on delay time	t _{d(on)}	-	34	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =24.8A, $R_{\rm G}$ =3.3 Ω ; see table 9	
Rise time	t _r	-	4	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =24.8A, $R_{\rm G}$ =3.3 Ω ; see table 9	
Turn-off delay time	$t_{ m d(off)}$	-	115	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =24.8A, $R_{\rm G}$ =3.3 Ω ; see table 9	
Fall time	t _f	-	3	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =24.8A, $R_{\rm G}$ =3.3 Ω ; see table 9	

¹⁾ We do not recommend using the CoolMOS mentioned in this datasheet to operate in "linear mode". For assessment of potential "linear mode", please contact Infineon sales office.

 $^{^{2)}}$ $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{3)}$ $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

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 Table 6
 Gate charge characteristics

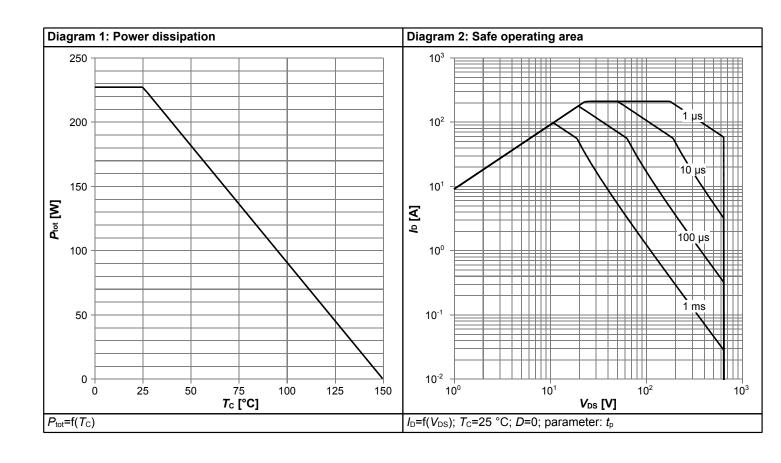
Parameter	Symbol	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Gate to source charge	Q _{gs}	-	29	-	nC	$V_{\rm DD}$ =400V, $I_{\rm D}$ =24.8A, $V_{\rm GS}$ =0 to 10V
Gate to drain charge	Q_{gd}	-	31	-	nC	V_{DD} =400V, I_{D} =24.8A, V_{GS} =0 to 10V
Gate charge total	Q g	-	102	-	nC	V_{DD} =400V, I_{D} =24.8A, V_{GS} =0 to 10V
Gate plateau voltage	V _{plateau}	-	5.7	-	V	V _{DD} =400V, I _D =24.8A, V _{GS} =0 to 10V

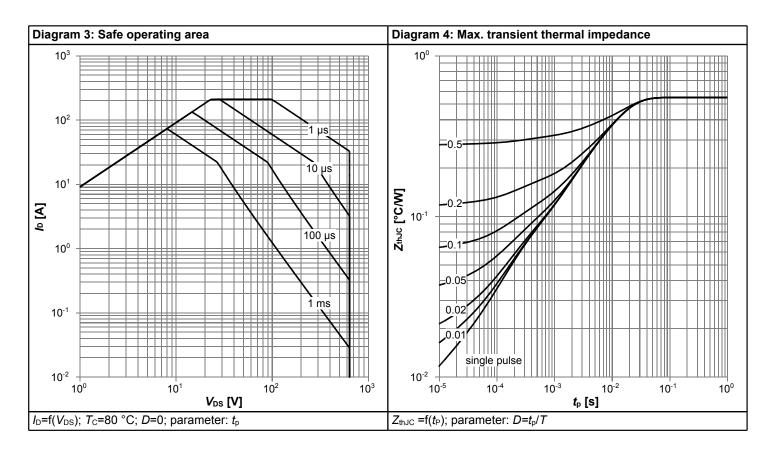
Table 7 Reverse diode characteristics

Parameter	Symbol	Values			11	Nata / Tank Candition
		Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	1.1	-	V	V _{GS} =0V, I _F =24.8A, T _j =25°C
Reverse recovery time	t _{rr}	-	177	-	ns	V_R =400V, I_F =24.8A, d_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Qrr	-	1.2	-	μC	V_R =400V, I_F =24.8A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	11.8	-	А	V_R =400V, I_F =24.8A, di_F/dt =100A/ μ s; see table 8

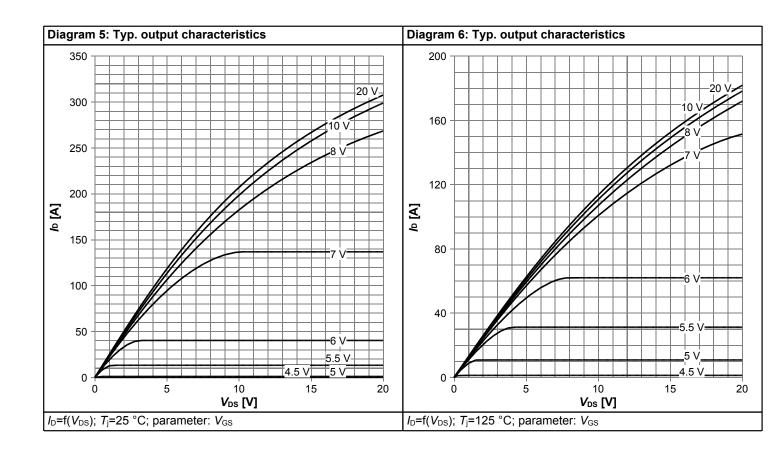


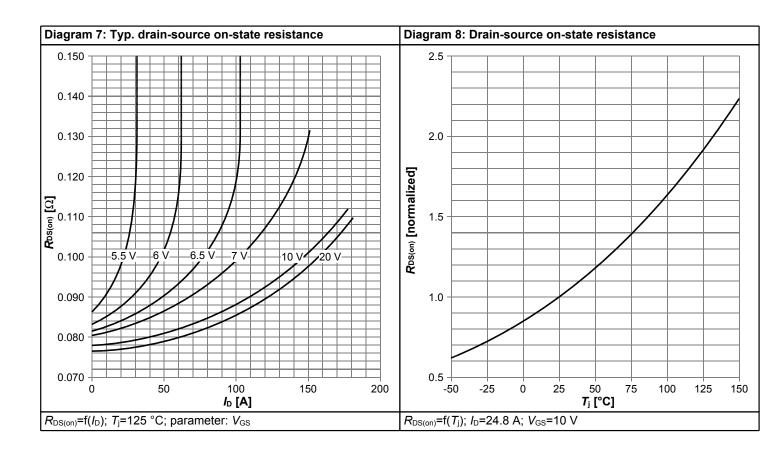
4 Electrical characteristics diagrams



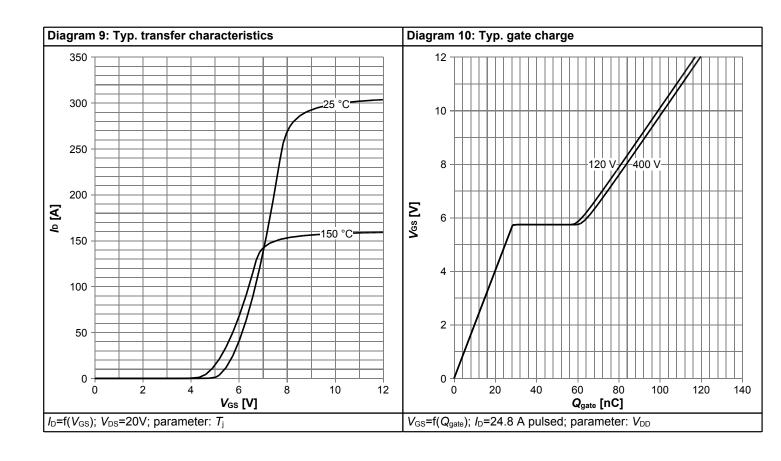


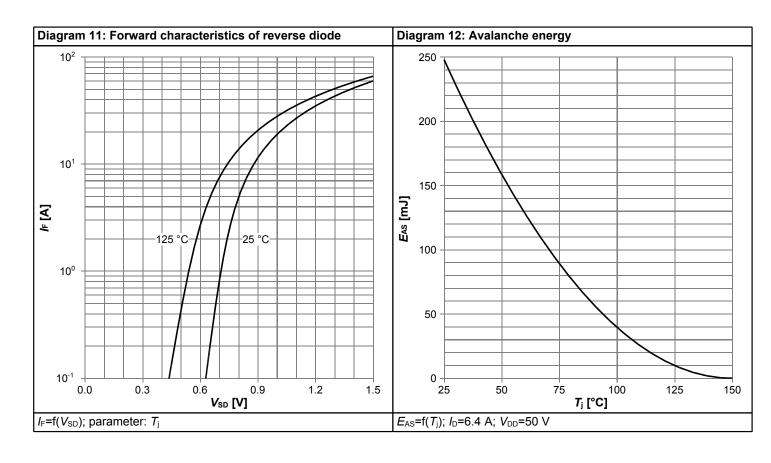




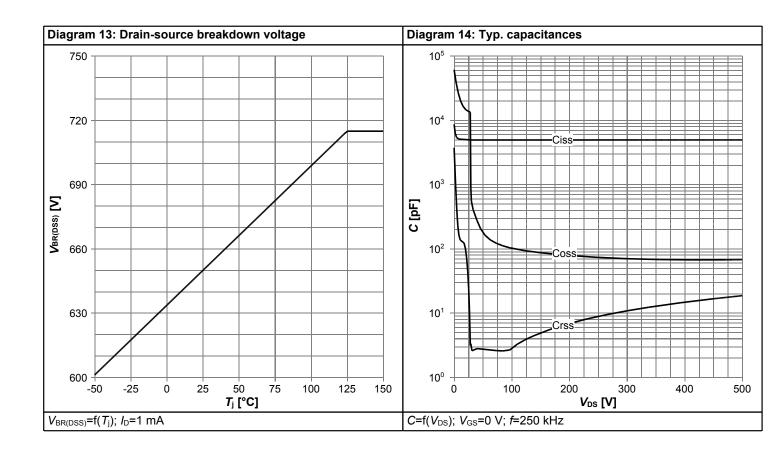


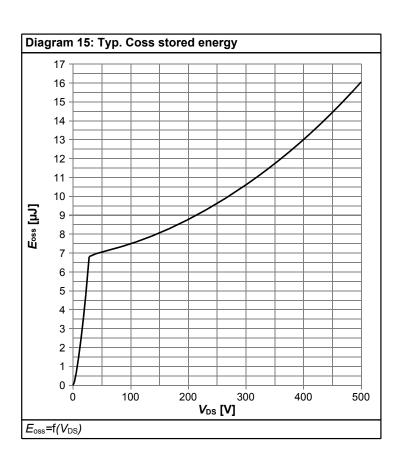
















5 Test Circuits

Table 8 Diode characteristics

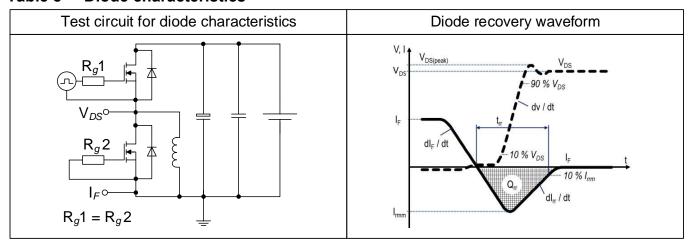
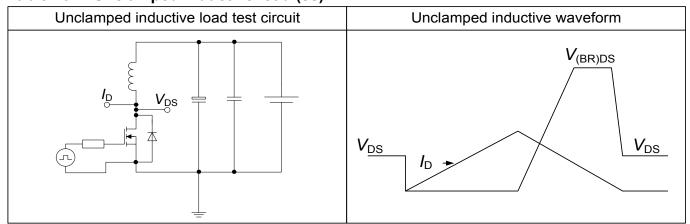


Table 9 Switching times (ss)



Table 10 Unclamped inductive load (ss)





6 Package Outlines

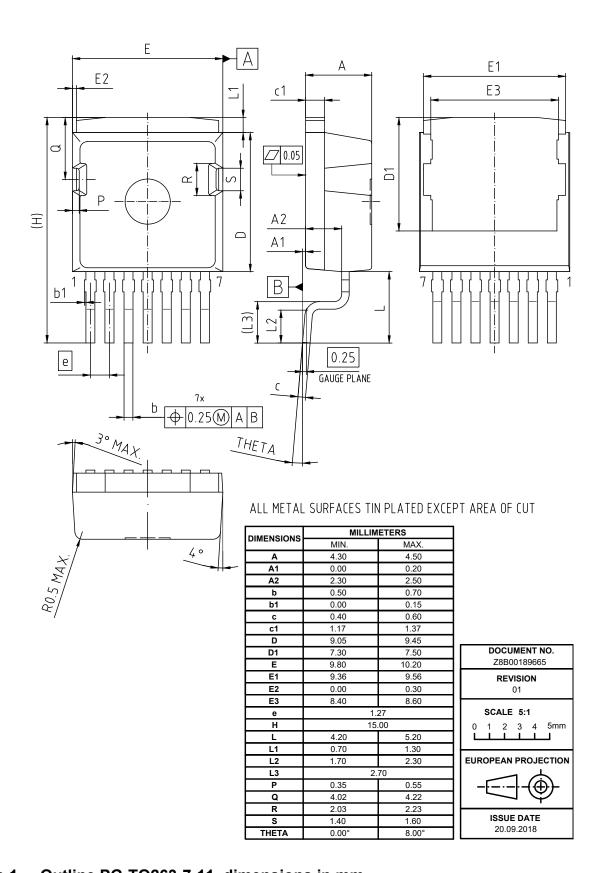


Figure 1 Outline PG-TO263-7-11, dimensions in mm

650V CoolMOS™ CFD7A SJ Power Device IPBE65R050CFD7A



7 Appendix A

Table 11 Related Links

• IFX CoolMOS CFD7A Webpage: www.infineon.com

• IFX CoolMOS CFD7A application note: www.infineon.com

• IFX CoolMOS CFD7A simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

IPBE65R050CFD7A



Revision History

IPBE65R050CFD7A

Revision: 2021-11-24, Rev. 2.2

Previous Revision

1 10 110 40 1	(01)01011	
Revision	Date	Subjects (major changes since last revision)
2.0	2020-03-04	Release of final version
2.1	2020-04-02	Updated marketing text and drain-source breakdown voltage footnote.
2.2	2021-11-24	Change of wording regarding breakdown voltage / cosmic ray

Trademarks

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